2SB1593

Silicon PNP epitaxial planar type

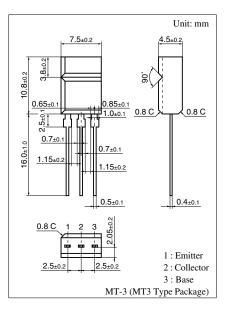
For low-frequency amplification

Features

- \bullet Low collector to emitter saturation voltage $V_{CE(sat)}$
- Allowing automatic insertion with radial taping

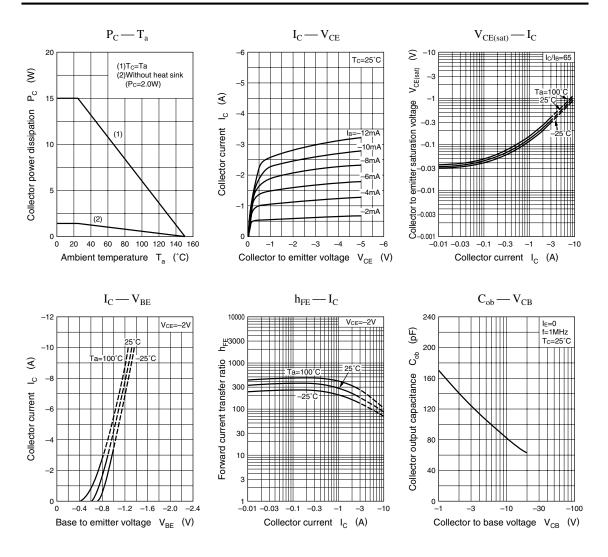
Symbol	Rating	Unit					
V _{CBO}	-29	V					
V _{CER}	-29	V					
V _{CEO}	-20	V					
V _{EBO}	-11	V					
I _{CP}	-10	А					
I _C	-3	А					
P _C	1.5	W					
Tj	150	°C					
T _{stg}	150	°C					
	V_{CBO} V_{CEO} V_{CEO} V_{EBO} I_{CP} I_{C} P_{C} T_{j}	$\begin{array}{c c c c c c c c c c c c c c c c c c c $					

Absolute Maximum Ratings $T_C = 25^{\circ}C$



Electrical Characteristics $T_C = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector to base voltage	V _{CBO}	$I_{\rm C} = -10 \ \mu A, \ I_{\rm E} = 0$	-29			v
Collector to emitter voltage	V _{CER}	$I_{\rm C}$ = -1 mA, $R_{\rm BE}$ = 10 k Ω	-29			v
	V _{CEO}	$I_{\rm C} = -1 \text{mA}, I_{\rm B} = 0$	-20			v
Emitter to base voltage	V_{EBO}	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$	-11			v
Forward current transfer ratio	h _{FE}	$V_{CE} = -2 V, I_C = -2.6 A$	100		450	
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = -2.6 \text{ A}, I_{\rm B} = -40 \text{ mA}$		- 0.3	- 0.5	v
Transition frequency	f_T	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance	C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		110	150	pF



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